

## High speed 1200 V TRENCHSTOP™ IGBT 7 Technology co-packed with full rated current, soft-commutating, ultra-fast recovery and low $Q_{rr}$ emitter controlled 7 Rapid diode

### Features

- $V_{CE} = 1200\text{ V}$
- $I_C = 75\text{ A}$
- Maximum junction temperature  $T_{vjmax} = 175^\circ\text{C}$
- Best-in-class high speed IGBT co-packed with full rated current, low  $Q_{rr}$  and soft-commutating high speed diode
- Low saturation voltage  $V_{CEsat} = 1.7\text{ V}$  at  $T_{vj} = 25^\circ\text{C}$
- Optimized for high efficiency in high speed hard switching topologies (2-L inverter, 3-L NPC T-type, ...)
- Easy paralleling capability due to positive temperature coefficient in  $V_{CEsat}$
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

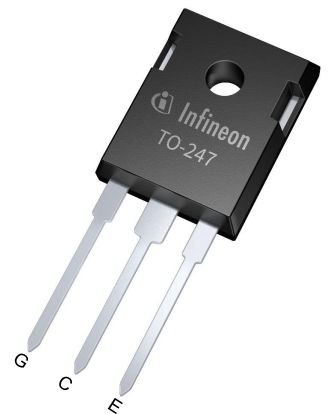
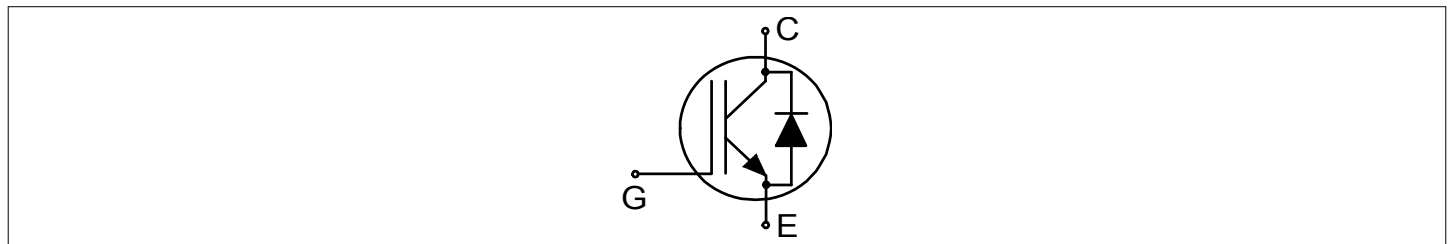
### Potential applications

- Industrial UPS
- EV-Charging
- String inverter
- Welding

### Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

### Description



| Type         | Package              | Marking |
|--------------|----------------------|---------|
| IKW75N120CH7 | PG-TO247-3-STD-NN2.5 | K75MCH7 |

## Table of contents

|          |                                       |    |
|----------|---------------------------------------|----|
|          | <b>Description</b> .....              | 1  |
|          | <b>Features</b> .....                 | 1  |
|          | <b>Potential applications</b> .....   | 1  |
|          | <b>Product validation</b> .....       | 1  |
|          | <b>Table of contents</b> .....        | 2  |
| <b>1</b> | <b>Package</b> .....                  | 3  |
| <b>2</b> | <b>IGBT</b> .....                     | 3  |
| <b>3</b> | <b>Diode</b> .....                    | 5  |
| <b>4</b> | <b>Characteristics diagrams</b> ..... | 7  |
| <b>5</b> | <b>Package outlines</b> .....         | 14 |
| <b>6</b> | <b>Testing conditions</b> .....       | 15 |
|          | <b>Revision history</b> .....         | 16 |
|          | <b>Disclaimer</b> .....               | 17 |

## 1 Package

**Table 1** Characteristic values

| Parameter   | Symbol        | Note or test condition                               | Values |      |      | Unit |
|---|---------------|--|--------|------|------|------|
|   |               |  | Min.   | Typ. | Max. |      |
| Internal emitter inductance measured 5 mm (0.197 in.) from case | $L_E$         |  |        | 13   |      | nH   |
| Storage temperature   | $T_{stg}$     |  | -55    |      | 150  | °C   |
| Soldering temperature   | $T_{sold}$    | wave soldering 1.6 mm (0.063 in.) from case for 10 s |        |      | 260  | °C   |
| Mounting torque   | $M$           | M3 screw, Maximum of mounting process: 3             |        |      | 0.6  | Nm   |
| Thermal resistance, junction-ambient                            | $R_{th(j-a)}$ |  |        |      | 40   | K/W  |
| IGBT thermal resistance, junction-case                          | $R_{th(j-c)}$ |  |        | 0.21 | 0.27 | K/W  |
| Diode thermal resistance, junction-case                         | $R_{th(j-c)}$ |  |        | 0.36 | 0.47 | K/W  |

## 2 IGBT

**Table 2** Maximum rated values

| Parameter  | Symbol       | Note or test condition  | Values                | Unit |   |
|--|--------------|---|-----------------------|------|---|
| Collector-emitter voltage                              | $V_{CE}$     | $T_{vj} \geq 25\text{ °C}$  | 1200                  | V    |   |
| DC collector current, limited by $T_{vjmax}$           | $I_C$        | limited by bondwire   | $T_c = 25\text{ °C}$  | 92   | A |
|  |              |   | $T_c = 100\text{ °C}$ | 81   |   |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpulse}$ |   | 300                   | A    |   |
| Turn-off safe operating area                           |              | $V_{CC} \leq 800\text{ V}$ , $V_{CE,peak} < 1200\text{ V}$ , $V_{GE} = 0/15\text{ V}$ , $R_{Goff} \geq 5.3\ \Omega$ , $T_{vj} \leq 175\text{ °C}$ | 300                   | A    |   |
| Gate-emitter voltage                                   | $V_{GE}$     |   | $\pm 20$              | V    |   |
| Transient gate-emitter voltage                         | $V_{GE}$     | $t_p \leq 0.5\ \mu\text{s}$ , $D < 0.001$   | $\pm 25$              | V    |   |
| Power dissipation                                      | $P_{tot}$    |   | $T_c = 25\text{ °C}$  | 549  | W |
|  |              |   | $T_c = 100\text{ °C}$ | 275  |   |

**Table 3** Characteristic values

| Parameter                            | Symbol      | Note or test condition                       | Values                   |      |      | Unit |
|--------------------------------------|-------------|--|--------------------------|------|------|------|
|                                      |             |  | Min.                     | Typ. | Max. |      |
| Collector-emitter saturation voltage | $V_{CEsat}$ | $I_C = 75\text{ A}$ , $V_{GE} = 15\text{ V}$ | $T_{vj} = 25\text{ °C}$  | 1.7  | 2.15 | V    |
|                                      |             |  | $T_{vj} = 175\text{ °C}$ | 2    |      |      |

(table continues...)  
 Datasheet

**Table 3 (continued) Characteristic values**

| Parameter                           | Symbol       | Note or test condition   | Values  |      |      | Unit          |
|-------------------------------------|--------------|--|---|------|------|---------------|
|                                     |              |  | Min.  | Typ. | Max. |               |
| Gate-emitter threshold voltage      | $V_{GEth}$   | $I_C = 1.2 \text{ mA}, V_{CE} = V_{GE}$  | 4.7   | 5.5  | 6.2  | V             |
| Zero gate-voltage collector current | $I_{CES}$    | $V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}$  | $T_{vj} = 25 \text{ }^\circ\text{C}$                      |      | 40   | $\mu\text{A}$ |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}$                     |      | 4600 |               |
| Gate-emitter leakage current        | $I_{GES}$    | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$  |   |      | 100  | nA            |
| Transconductance                    | $g_{fs}$     | $I_C = 75 \text{ A}, V_{CE} = 20 \text{ V}$  |   | 123  |      | S             |
| Input capacitance                   | $C_{ies}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$   |   | 9.6  |      | nF            |
| Output capacitance                  | $C_{oes}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$   |   | 184  |      | pF            |
| Reverse transfer capacitance        | $C_{res}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$   |   | 54   |      | pF            |
| Gate charge                         | $Q_G$        | $I_C = 75 \text{ A}, V_{GE} = 15 \text{ V}, V_{CC} = 960 \text{ V}$  |   | 535  |      | nC            |
| Turn-on delay time                  | $t_{d(on)}$  | $V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 8 \text{ } \Omega, R_{G(off)} = 8 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$  |      | 55   | ns            |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$ |      | 52   |               |
| Rise time (inductive load)          | $t_r$        | $V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 8 \text{ } \Omega, R_{G(off)} = 8 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$  |      | 41   | ns            |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$ |      | 36   |               |
| Turn-off delay time                 | $t_{d(off)}$ | $V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 8 \text{ } \Omega, R_{G(off)} = 8 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$  |      | 461  | ns            |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$ |      | 527  |               |
| Fall time (inductive load)          | $t_f$        | $V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 8 \text{ } \Omega, R_{G(off)} = 8 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$  |      | 32   | ns            |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$ |      | 97   |               |
| Turn-on energy                      | $E_{on}$     | $V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 8 \text{ } \Omega, R_{G(off)} = 8 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$  |      | 4.22 | mJ            |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$ |      | 5.86 |               |
| Turn-off energy                     | $E_{off}$    | $V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 8 \text{ } \Omega, R_{G(off)} = 8 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$  |      | 1.66 | mJ            |
|                                     |              |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 75 \text{ A}$ |      | 3.37 |               |

(table continues...)

**Table 3 (continued) Characteristic values**

| Parameter                      | Symbol   | Note or test condition   | Values  |      |      | Unit             |    |
|--------------------------------|----------|--|---|------|------|------------------|----|
|                                |          |  | Min.  | Typ. | Max. |                  |    |
| Total switching energy         | $E_{ts}$ | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_C = 75\text{ A}$  |      | 5.88 |                  | mJ |
|                                |          |  | $T_{vj} = 175\text{ }^\circ\text{C}, I_C = 75\text{ A}$ |      | 9.23 |                  |    |
| Operating junction temperature | $T_{vj}$ |  | -40   |      | 175  | $^\circ\text{C}$ |    |

Note: Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified.

### 3 Diode

**Table 4 Maximum rated values**

| Parameter  | Symbol       | Note or test condition | Values                            | Unit |   |
|--|--------------|------------------------|-----------------------------------|------|---|
| Diode forward current, limited by $T_{vjmax}$      | $I_F$        | limited by bondwire    | $T_c = 25\text{ }^\circ\text{C}$  | 89   | A |
|  |              |                        | $T_c = 97\text{ }^\circ\text{C}$  | 75   |   |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$ | $I_{Fpulse}$ |                        | 300                               | A    |   |
| Power dissipation                                  | $P_{tot}$    |                        | $T_c = 25\text{ }^\circ\text{C}$  | 321  | W |
|  |              |                        | $T_c = 100\text{ }^\circ\text{C}$ | 160  |   |

**Table 5 Characteristic values**

| Parameter                           | Symbol    | Note or test condition                      | Values  |      |      | Unit |               |
|-------------------------------------|-----------|---|---|------|------|------|---------------|
|                                     |           |   | Min.  | Typ. | Max. |      |               |
| Diode forward voltage               | $V_F$     | $I_F = 75\text{ A}$                         | $T_{vj} = 25\text{ }^\circ\text{C}$                     |      | 2.5  | 3    | V             |
|                                     |           |   | $T_{vj} = 175\text{ }^\circ\text{C}$                    |      | 2.3  |      |               |
| Diode reverse recovery time         | $t_{rr}$  | $V_R = 600\text{ V}, R_{G(on)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_F = 75\text{ A}$  |      | 145  |      | ns            |
|                                     |           |   | $T_{vj} = 175\text{ }^\circ\text{C}, I_F = 75\text{ A}$ |      | 218  |      |               |
| Diode reverse recovery charge       | $Q_{rr}$  | $V_R = 600\text{ V}, R_{G(on)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_F = 75\text{ A}$  |      | 2.32 |      | $\mu\text{C}$ |
|                                     |           |   | $T_{vj} = 175\text{ }^\circ\text{C}, I_F = 75\text{ A}$ |      | 6.41 |      |               |
| Diode peak reverse recovery current | $I_{rrm}$ | $V_R = 600\text{ V}, R_{G(on)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_F = 75\text{ A}$  |      | 35   |      | A             |
|                                     |           |   | $T_{vj} = 175\text{ }^\circ\text{C}, I_F = 75\text{ A}$ |      | 62   |      |               |

(table continues...)

**Table 5 (continued) Characteristic values**

| Parameter   | Symbol       | Note or test condition                      | Values   |      |       | Unit |                  |
|---|--------------|---|--|------|-------|------|------------------|
|   |              |   | Min.   | Typ. | Max.  |      |                  |
| Diode peak rate of fall of reverse recovery current | $di_{rr}/dt$ | $V_R = 600 \text{ V}, R_{G(on)} = 8 \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$  |      | -333  |      | A/ $\mu\text{s}$ |
|   |              |   | $T_{vj} = 150 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$ |      | -394  |      |                  |
| Reverse recovery energy                             | $E_{rec}$    | $V_R = 600 \text{ V}, R_{G(on)} = 8 \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$  |      | 0.701 |      | mJ               |
|   |              |   | $T_{vj} = 175 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$ |      | 2.16  |      |                  |
| Operating junction temperature                      | $T_{vj}$     |   |  | -40  |       | 175  | $^\circ\text{C}$ |

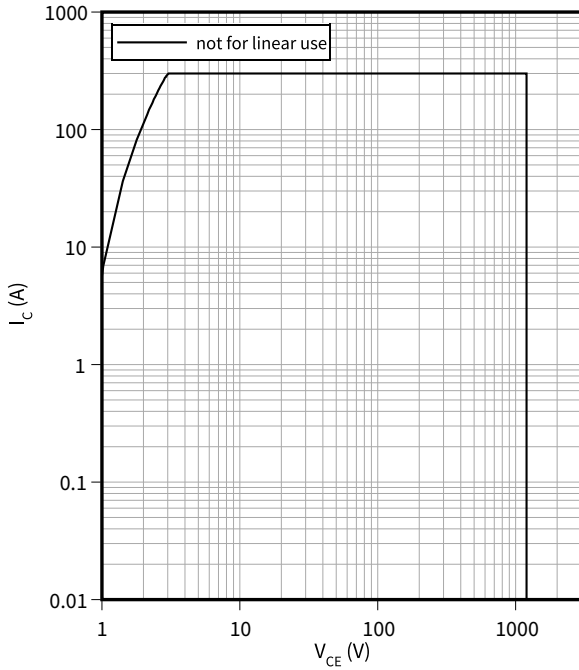
*Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.*

*Dynamic test circuit, parasitic inductance  $L_\sigma = 30 \text{ nH}$ ,  $C_\sigma = 18 \text{ pF}$*

## 4 Characteristics diagrams

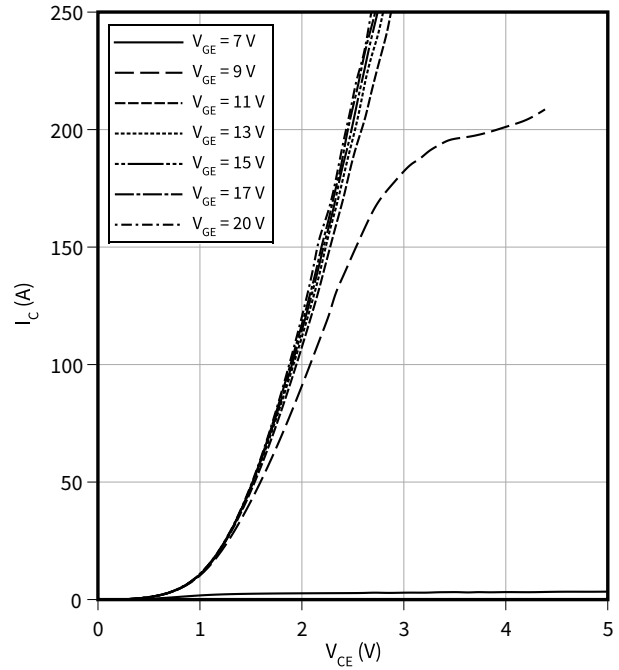
### Reverse bias safe operating area

$I_C = f(V_{CE})$   
 $T_{vj} \leq 175\text{ °C}, V_{GE} = 0/15\text{ V}$



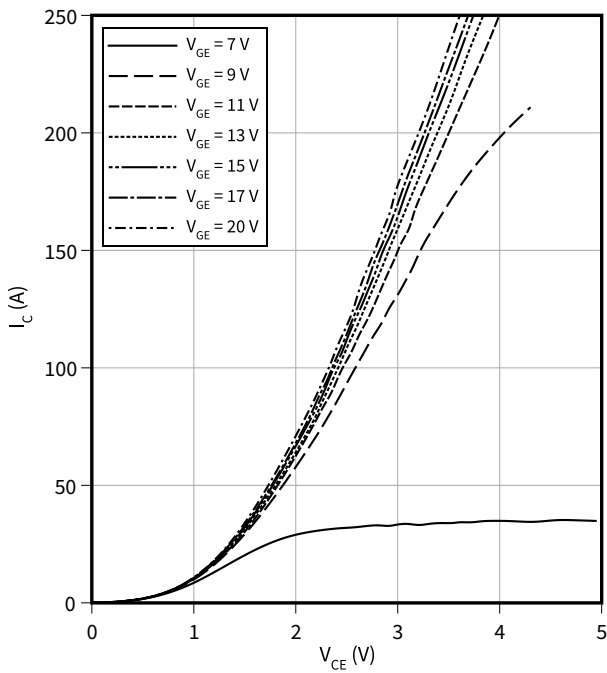
### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 25\text{ °C}$



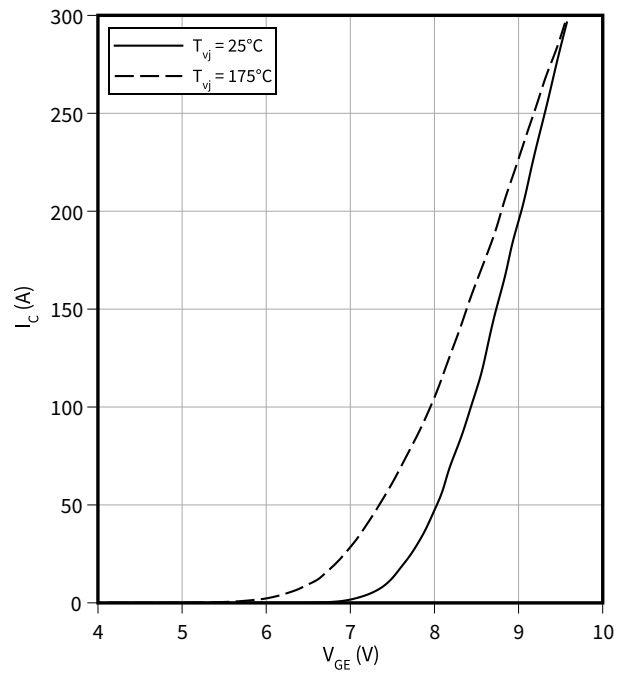
### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$



### Typical transfer characteristic

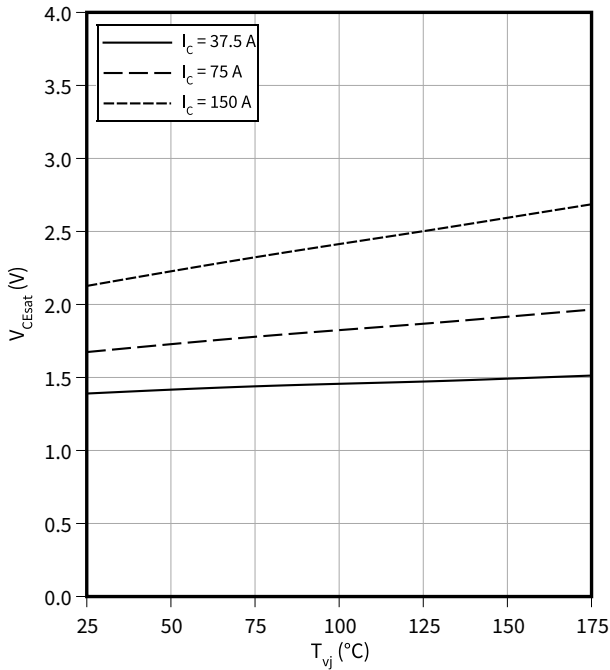
$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



4 Characteristics diagrams

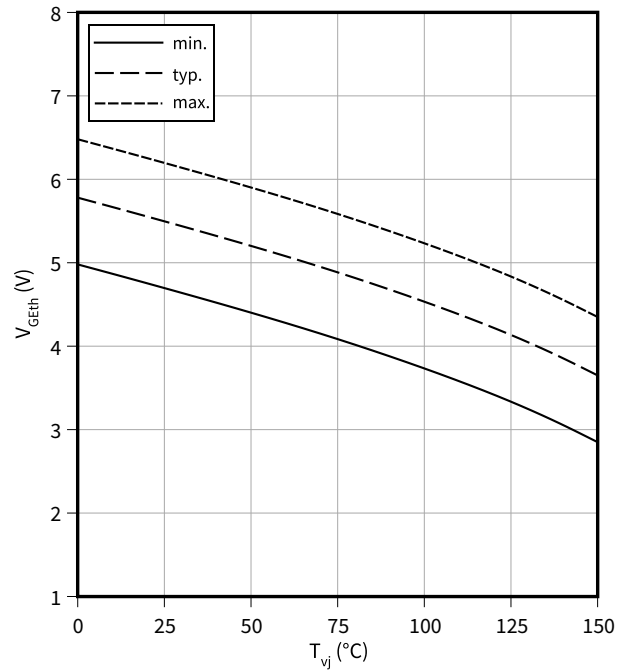
**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15 \text{ V}$



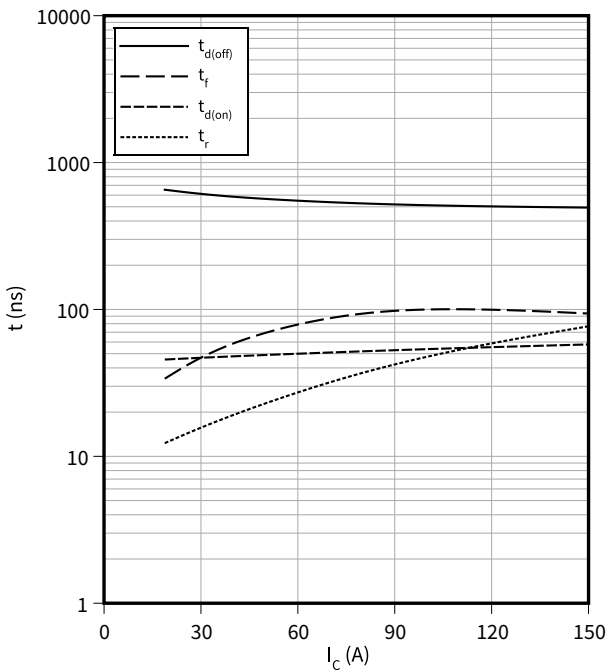
**Gate-emitter threshold voltage as a function of junction temperature**

$V_{GEth} = f(T_{vj})$   
 $I_c = 1.2 \text{ mA}$



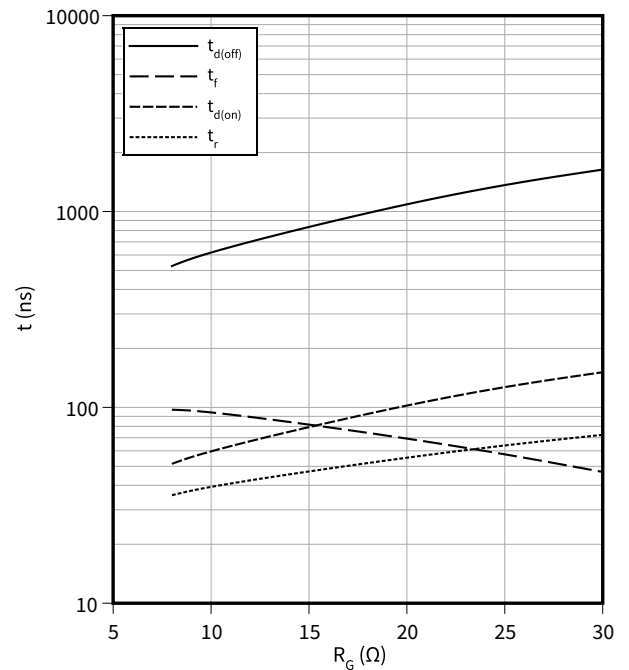
**Typical switching times as a function of collector current**

$t = f(I_c)$   
 $V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 8 \text{ } \Omega$



**Typical switching times as a function of gate resistor**

$t = f(R_G)$   
 $I_c = 75 \text{ A}, V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$



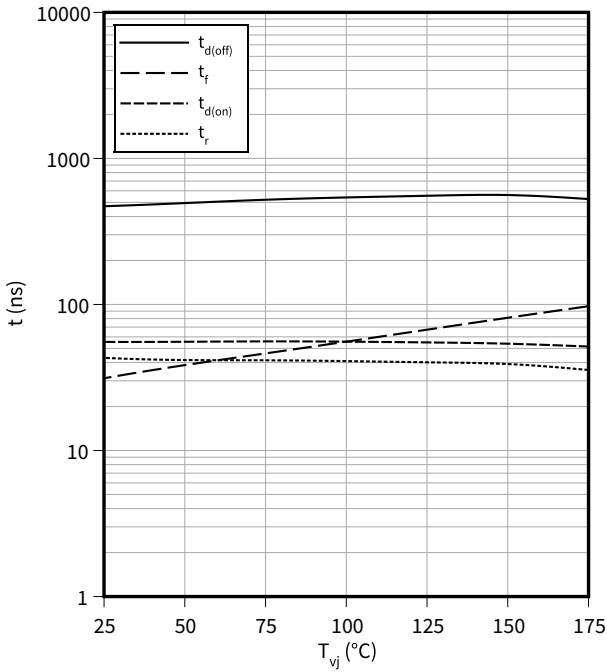


4 Characteristics diagrams

**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

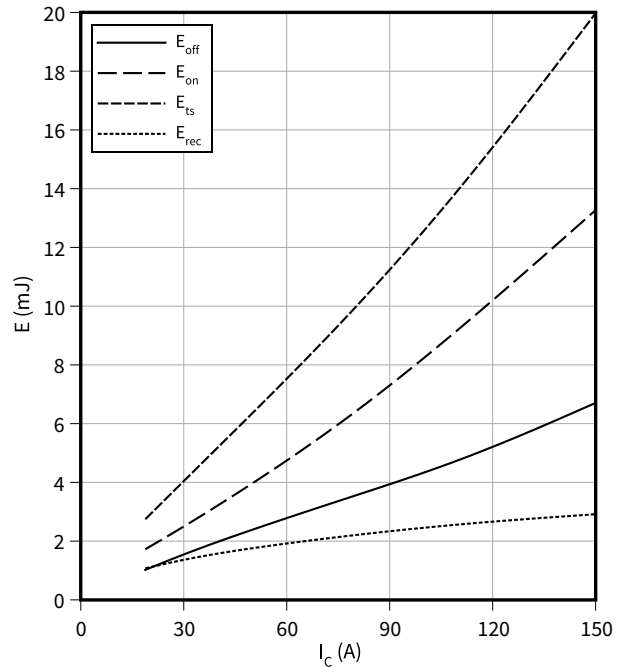
$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 8 \Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

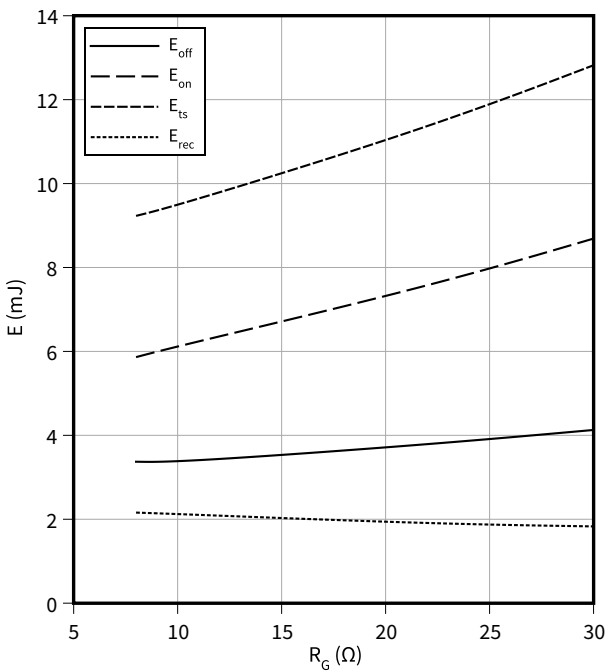
$V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 8 \Omega$



**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$

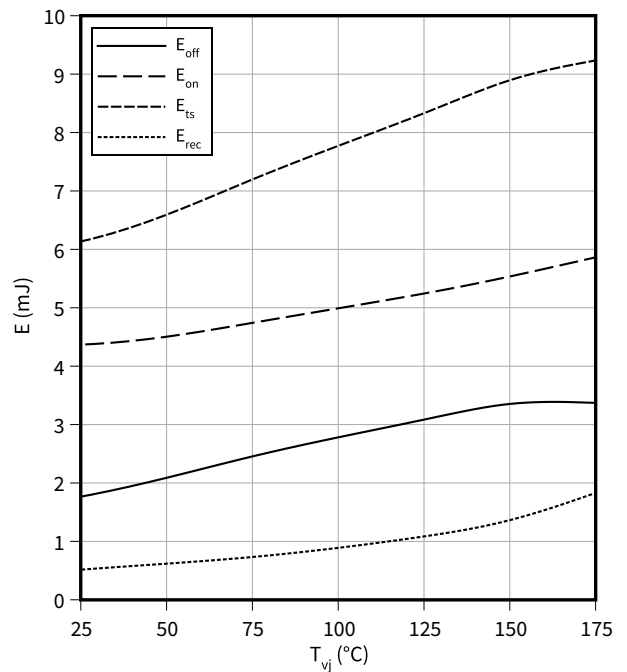
$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$



**Typical switching energy losses as a function of junction temperature**

$E = f(T_{vj})$

$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 8 \Omega$

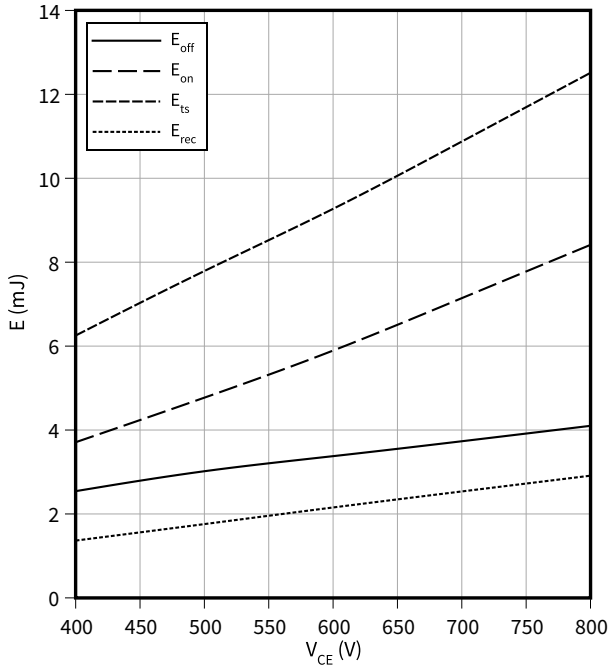


4 Characteristics diagrams

**Typical switching energy losses as a function of collector emitter voltage**

$E = f(V_{CE})$

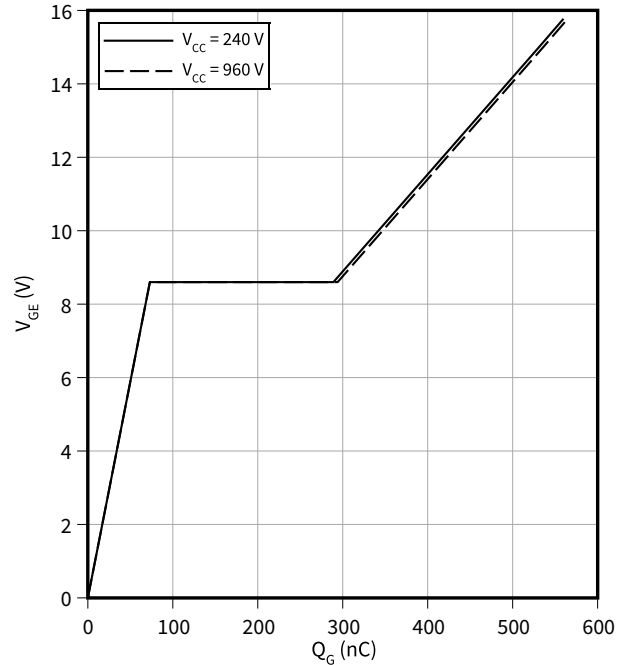
$I_C = 75 \text{ A}$ ,  $T_{vj} = 175 \text{ °C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 8 \text{ } \Omega$



**Typical gate charge**

$V_{GE} = f(Q_G)$

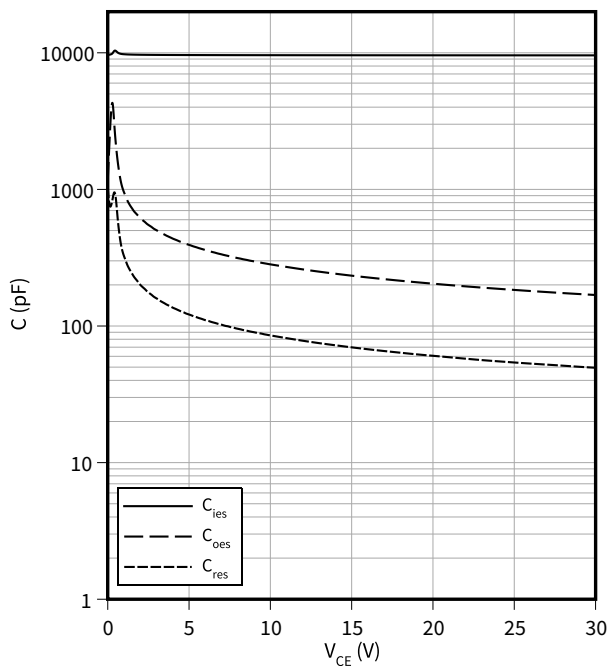
$I_C = 75 \text{ A}$



**Typical capacitance as a function of collector-emitter voltage**

$C = f(V_{CE})$

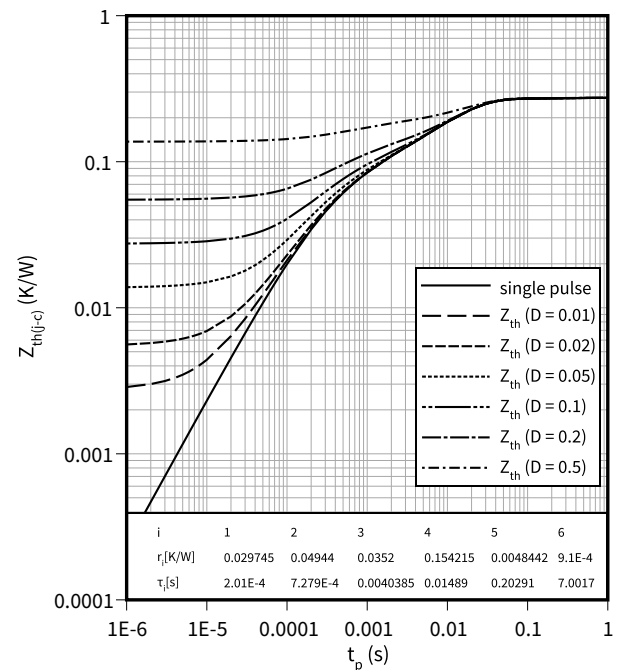
$f = 100 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$



**IGBT transient thermal impedance as a function of pulse width**

$Z_{th(j-c)} = f(t_p)$

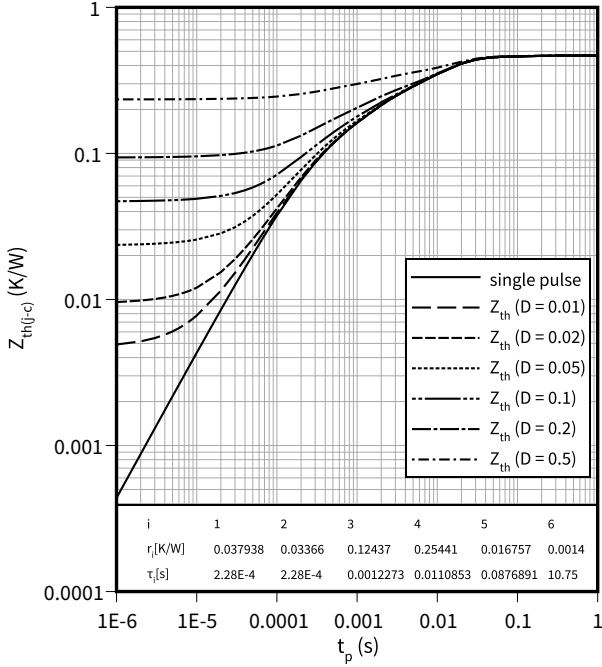
$D = t_p/T$



4 Characteristics diagrams

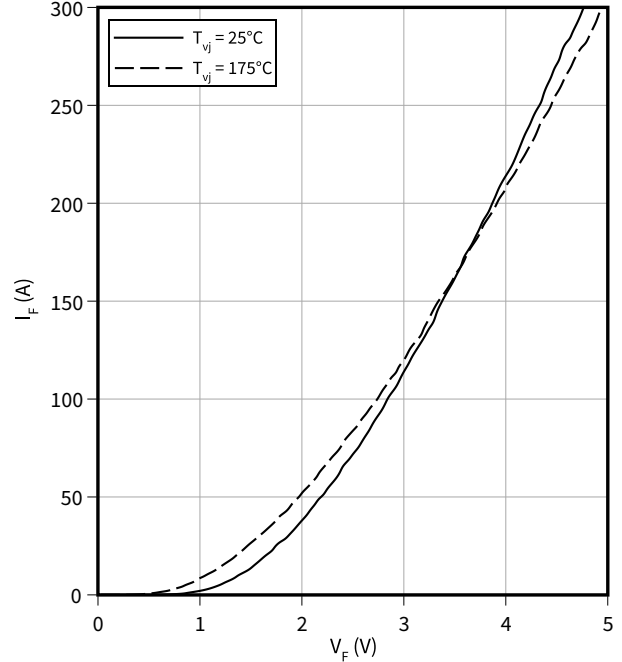
**Diode transient thermal impedance as a function of pulse width**

$Z_{th(j-c)} = f(t_p)$   
 $D = t_p/T$



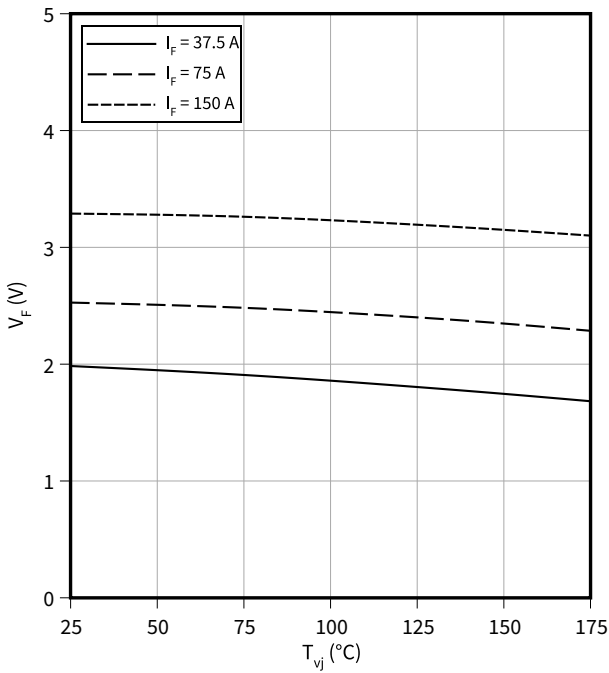
**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



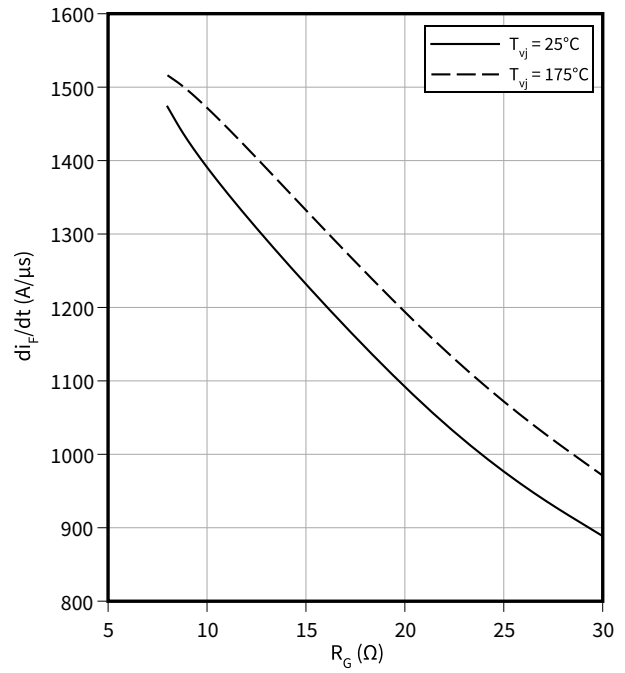
**Typical diode forward voltage as a function of junction temperature**

$V_F = f(T_{vj})$



**Typical diode current slope as a function of gate resistor**

$di_F/dt = f(R_G)$   
 $V_R = 600 \text{ V}, I_F = 75 \text{ A}$

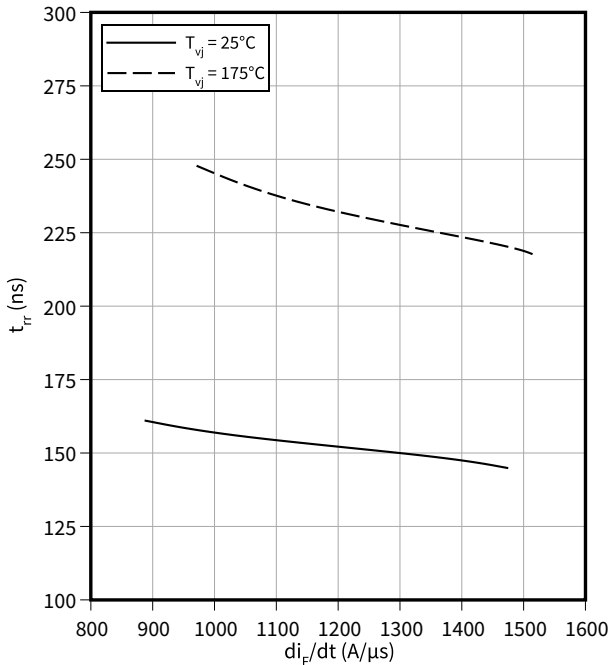


4 Characteristics diagrams

**Typical reverse recovery time as a function of diode current slope**

$t_{rr} = f(di_F/dt)$

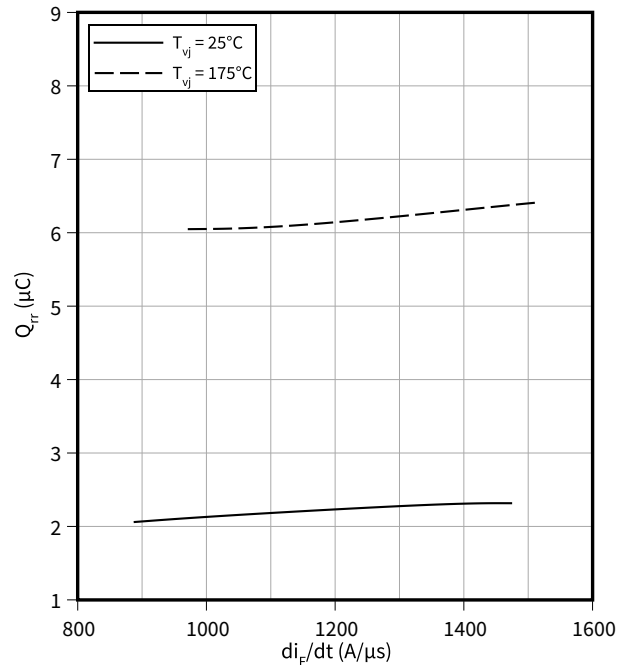
$V_R = 600\text{ V}, I_F = 75\text{ A}$



**Typical reverse recovery charge as a function of diode current slope**

$Q_{rr} = f(di_F/dt)$

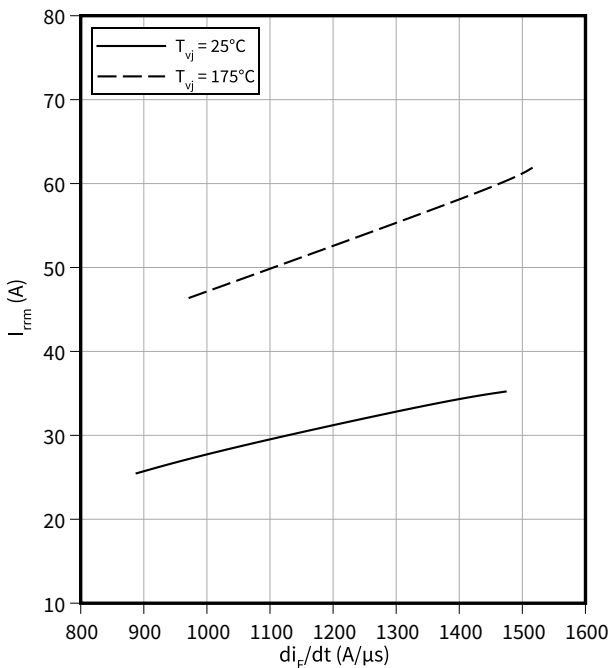
$V_R = 600\text{ V}, I_F = 75\text{ A}$



**Typical reverse recovery current as a function of diode current slope**

$I_{rrm} = f(di_F/dt)$

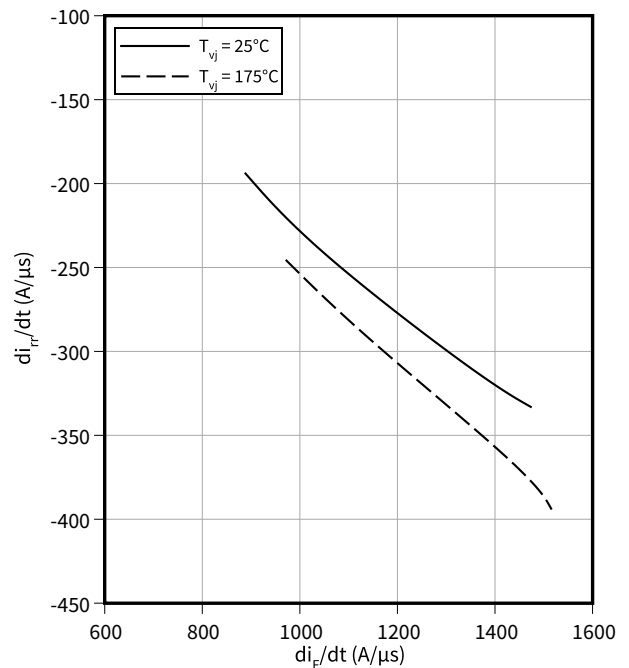
$V_R = 600\text{ V}, I_F = 75\text{ A}$



**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

$di_{rr}/dt = f(di_F/dt)$

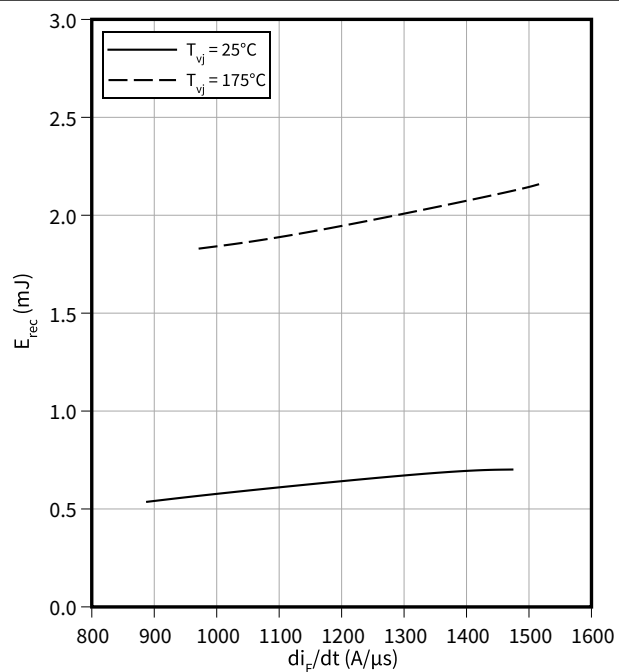
$V_R = 600\text{ V}, I_F = 75\text{ A}$



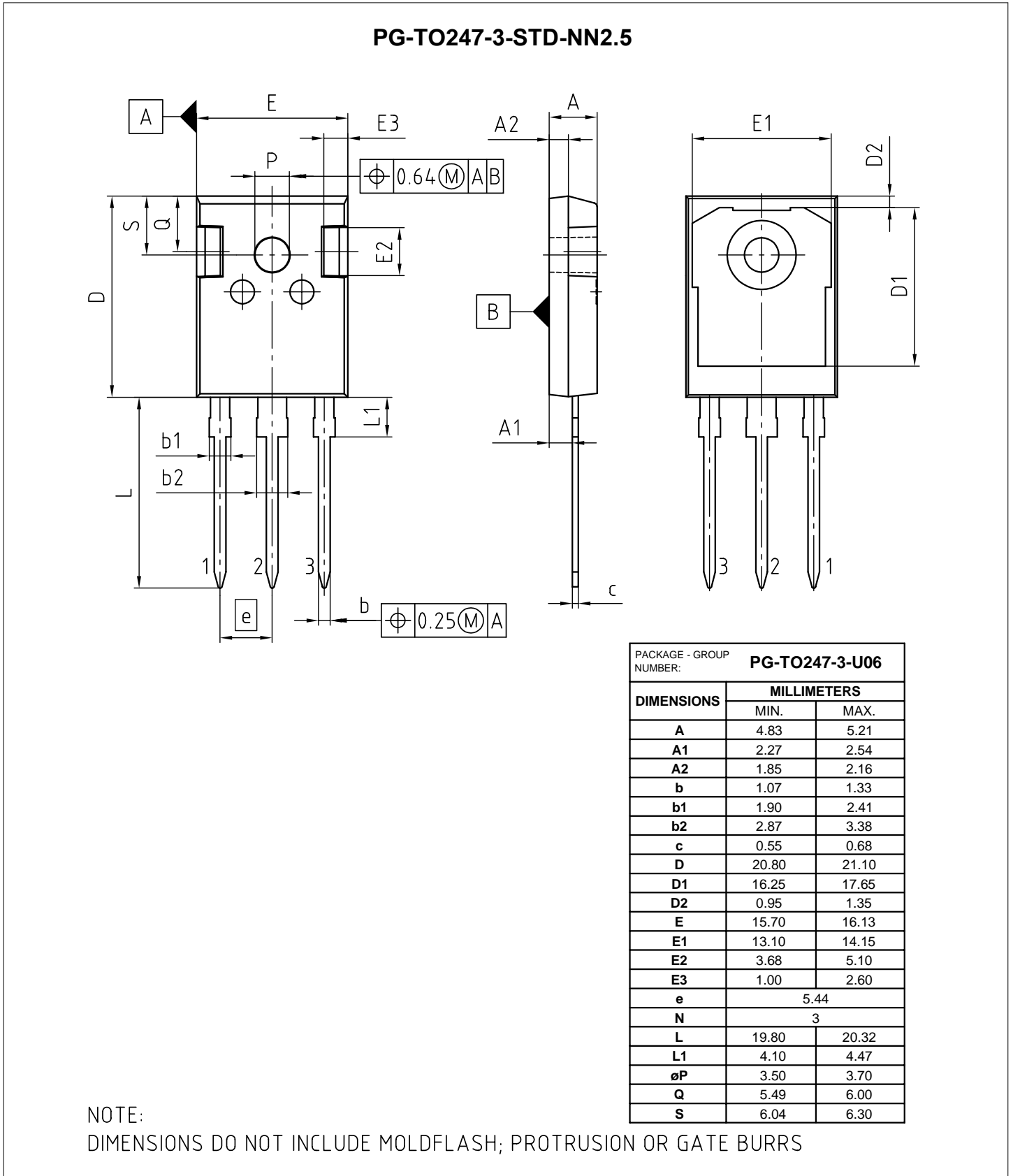
**Typical reverse energy losses as a function of diode current slope**

$$E_{\text{rec}} = f(di_F/dt)$$

$V_R = 600 \text{ V}$ ,  $I_F = 75 \text{ A}$



**5 Package outlines**



**Figure 1**

**6 Testing conditions**



**Figure 2**

## Revision history

| Document revision | Date of release | Description of changes           |
|-------------------|-----------------|----------------------------------|
| 0.10              | 2022-05-02      | Target datasheet                 |
| 0.20              | 2022-05-19      | Editorial changes                |
| 0.30              | 2022-06-01      | Editorial changes                |
| 1.00              | 2022-11-09      | Final datasheet                  |
| 1.10              | 2022-11-29      | Update of potential applications |



## Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Edition 2022-11-29**

**Published by**

**Infineon Technologies AG**

**81726 Munich, Germany**

**© 2022 Infineon Technologies AG**

**All Rights Reserved.**

**Do you have a question about any aspect of this document?**

**Email: [erratum@infineon.com](mailto:erratum@infineon.com)**

**Document reference**

**IFX-ABB249-005**

## Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.